

AUTOMOTIVE

COMPLIANT

**GREEN** 

(5-2008)

## High Speed Infrared Emitting Diodes, 850 nm, GaAlAs, DH



#### **DESCRIPTION**

VSMG2000X01 series are infrared, 850 nm emitting diodes in GaAlAs (DH) technology with high radiant power and high speed, molded in clear, untinted plastic packages (with lens) for surface mounting (SMD).

#### **FEATURES**

Package type: surface mount

· Package form: GW, RGW

• Dimensions (L x W x H in mm): 2.3 x 2.3 x 2.8

• AEC-Q101 qualified

Peak wavelength: λ<sub>p</sub> = 850 nm

· High reliability

· High radiant power

High radiant intensity

• Angle of half intensity:  $\varphi = \pm 12^{\circ}$ 

· Low forward voltage

• Suitable for high pulse current operation

· Terminal configurations: gullwing or reserve gullwing

• Package matches with detector VEMD2000X01 series

Floor life: 4 weeks, MSL 2a, acc. J-STD-020

 Material categorization: For definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

#### **APPLICATIONS**

- IrDA compatible data transmission
- IR-illumination (CCTV)
- Miniature light barrier
- Photointerrupters
- · Optical switch
- · Shaft encoders
- IR emitter source for proximity applications

| PRODUCT SUMMARY |                        |         |                     |                     |
|-----------------|------------------------|---------|---------------------|---------------------|
| COMPONENT       | I <sub>e</sub> (mW/sr) | φ (deg) | λ <sub>p</sub> (nm) | t <sub>r</sub> (ns) |
| VSMG2000X01     | 40                     | ± 12    | 850                 | 20                  |
| VSMG2020X01     | 40                     | ± 12    | 850                 | 20                  |

#### Note

Test conditions see table "Basic Characteristics"

| ORDERING INFORMATION |               |                              |                  |  |
|----------------------|---------------|------------------------------|------------------|--|
| ORDERING CODE        | PACKAGING     | REMARKS                      | PACKAGE FORM     |  |
| VSMG2000X01          | Tape and reel | MOQ: 6000 pcs, 6000 pcs/reel | Reverse gullwing |  |
| VSMG2020X01          | Tape and reel | MOQ: 6000 pcs, 6000 pcs/reel | Gullwing         |  |

#### Note

MOQ: minimum order quantity



| <b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>amb</sub> = 25 °C, unless otherwise specified) |   |                   |               |      |
|--|---|-------------------|---------------|------|
| PARAMETER  | TEST CONDITION                            | SYMBOL            | VALUE         | UNIT |
| Reverse voltage  |   | V <sub>R</sub>    | 5             | V    |
| Forward current  |   | I <sub>F</sub>    | 100           | mA   |
| Peak forward current   | $t_p/T = 0.5, t_p = 100 \mu s$            | I <sub>FM</sub>   | 200           | mA   |
| Surge forward current  | t <sub>p</sub> = 100 μs                   | I <sub>FSM</sub>  | 1             | Α    |
| Power dissipation  |   | P <sub>V</sub>    | 170           | mW   |
| Junction temperature   |   | Tj                | 100           | °C   |
| Operating temperature range  |   | T <sub>amb</sub>  | - 40 to + 85  | °C   |
| Storage temperature range  |   | T <sub>stg</sub>  | - 40 to + 100 | °C   |
| Soldering temperature  | Acc. figure 9, J-STD-020                  | T <sub>sd</sub>   | 260           | °C   |
| Thermal resistance junction/ambient  | J-STD-051, leads 7 mm,<br>soldered on PCB | R <sub>thJA</sub> | 250           | K/W  |

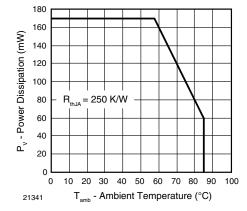


Fig. 1 - Power Dissipation Limit vs. Ambient Temperature

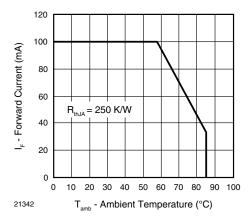


Fig. 2 - Forward Current Limit vs. Ambient Temperature

| <b>BASIC CHARACTERISTICS</b> (T <sub>amb</sub> = 25 °C, unless otherwise specified) |   |                  |      |        |      |       |
|---|---|------------------|------|--------|------|-------|
| PARAMETER   | TEST CONDITION  | SYMBOL           | MIN. | TYP.   | MAX. | UNIT  |
| Forward voltage   | $I_F = 100 \text{ mA}, t_p = 20 \text{ ms}$                   | $V_{F}$          | 1.25 | 1.45   | 1.7  | V     |
|   | $I_F = 1 \text{ A}, t_p = 100 \mu \text{s}$                   | $V_{F}$          |      | 2.3    |      | V     |
| Temperature coefficient of V <sub>F</sub>   | I <sub>F</sub> = 1 mA   | TK <sub>VF</sub> |      | - 1.8  |      | mV/K  |
|   | I <sub>F</sub> = 100 mA                                       | TK <sub>VF</sub> |      | - 1.1  |      | mV/K  |
| Reverse current   | V <sub>R</sub> = 5 V  | I <sub>R</sub>   |      |        | 10   | μΑ    |
| Junction capacitance  | $V_R = 0 \text{ V, f} = 1 \text{ MHz, E} = 0 \text{ mW/cm}^2$ | CJ               |      | 125    |      | pF    |
| D. II   | $I_F = 100 \text{ mA}, t_p = 20 \text{ ms}$                   | l <sub>e</sub>   | 20   | 40     | 60   | mW/sr |
| Radiant intensity   | $I_F = 1 \text{ A}, t_p = 100 \mu \text{s}$                   | l <sub>e</sub>   |      | 350    |      | mW/sr |
| Radiant power   | $I_F = 100 \text{ mA}, t_p = 20 \text{ ms}$                   | фe               |      | 40     |      | mW    |
| Temperature coefficient of φ <sub>e</sub>   | I <sub>F</sub> = 100 mA                                       | TKφ <sub>e</sub> |      | - 0.35 |      | %/K   |
| Angle of half intensity   |   | φ                |      | ± 12   |      | deg   |
| Peak wavelength   | I <sub>F</sub> = 30 mA  | $\lambda_{p}$    | 830  | 850    | 870  | nm    |
| Spectral bandwidth  | I <sub>F</sub> = 30 mA  | Δλ               |      | 35     |      | nm    |
| Temperature coefficient of $\lambda_p$  | I <sub>F</sub> = 30 mA  | TKλ <sub>p</sub> |      | 0.25   |      | nm/K  |
| Rise time   | I <sub>F</sub> = 100 mA, 20 % to 80 %                         | t <sub>r</sub>   |      | 20     |      | ns    |
| Fall time   | I <sub>F</sub> = 100 mA, 20 % to 80 %                         | t <sub>f</sub>   |      | 20     |      | ns    |
| Cut-off frequency   | I <sub>DC</sub> = 70 mA, I <sub>AC</sub> = 30 mA pp           | f <sub>c</sub>   |      | 23     |      | MHz   |
| Virtual source diameter   |   | d                |      | 1.5    |      | mm    |

### **BASIC CHARACTERISTICS** (T<sub>amb</sub> = 25 °C, unless otherwise specified)

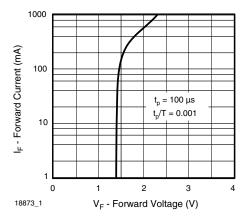


Fig. 3 - Forward Current vs. Forward Voltage

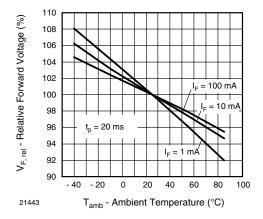


Fig. 4 - Relative Forward Voltage vs. Ambient Temperature

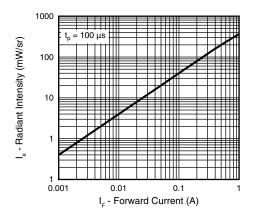


Fig. 5 - Radiant Intensity vs. Forward Current

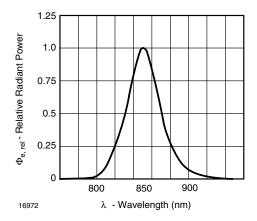


Fig. 6 - Relative Radiant Power vs. Wavelength

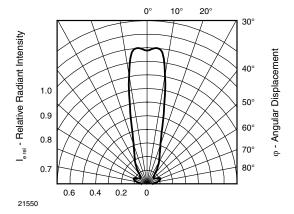


Fig. 7 - Relative Radiant Intensity vs. Angular Displacement

#### **SOLDER PROFILE**

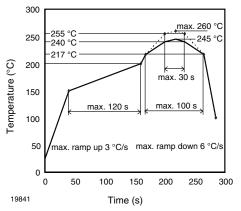


Fig. 8 - Lead (Pb)-free Reflow Solder Profile acc. J-STD-020

#### **DRYPACK**

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

#### **FLOOR LIFE**

Floor life (time between soldering and removing from MBB) must not exceed the time indicated on MBB label:

Floor life: 4 weeks

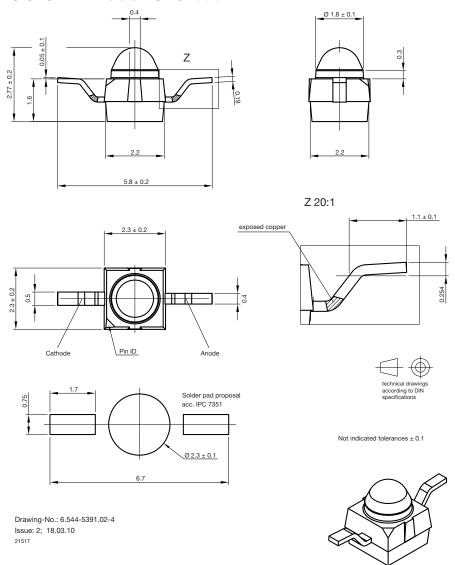
Conditions:  $T_{amb}$  < 30 °C, RH < 60 %

Moisture sensitivity level 2a, acc. to J-STD-020.

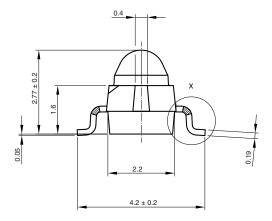
#### **DRYING**

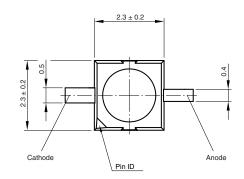
In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or label. Devices taped on reel dry using recommended conditions 192 h at 40  $^{\circ}$ C (+ 5  $^{\circ}$ C), RH < 5  $^{\circ}$ K.

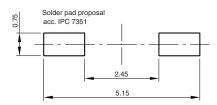
#### **PACKAGE DIMENSIONS** in millimeters: **VSMG2000**



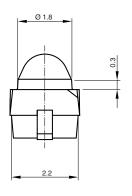
#### **PACKAGE DIMENSIONS** in millimeters: **VSMG2020**

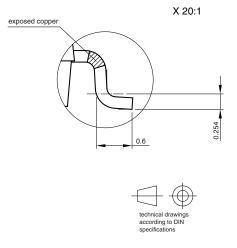




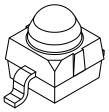


Drawing-No.: 6.544-5383.02-4 Issue: 4; 18.03.10



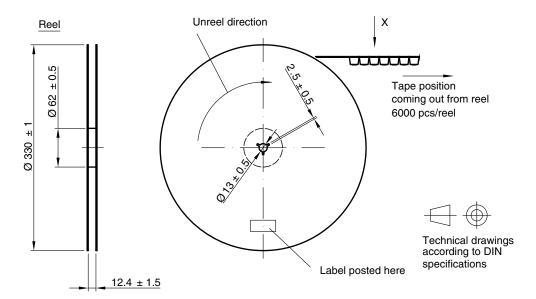


Not indicated tolerances  $\pm$  0.1

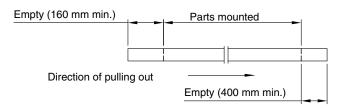




#### TAPING AND REEL DIMENSIONS in millimeters: VSMG2000

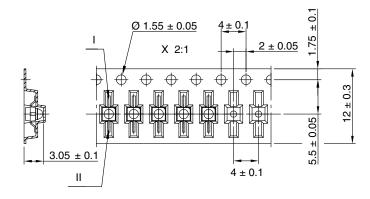


Leader and trailer tape:



#### Terminal position in tape

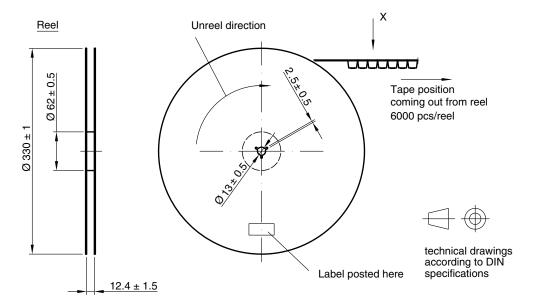
| Devicce    | Lead I    | Lead II |
|------------|-----------|---------|
| VEMT2000   |           |         |
| VEMT2500   | Collector | Emitter |
| VEMD2000   |           |         |
| VEMD2500   | Cathode   | Anode   |
| VSMB2000   | Calriode  | Anode   |
| VSMG2000   |           |         |
| VSMY2850RG | Anode     | Cathode |



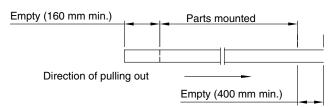
Drawing-No.: 9.800-5100.01-4 Issue: 2; 18.03.10

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#### TAPING AND REEL DIMENSIONS in millimeters: VSMG2020

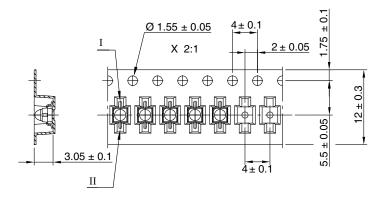


#### Leader and trailer tape:



#### Terminal position in tape

| Lead I    | Lead II   |
|-----------|-----------|
|           |           |
| Collector | Emitter   |
|           |           |
| Cathada   | Anode     |
| Camode    | Anode     |
|           |           |
| Anode     | Cathode   |
|           | Collector |



Drawing-No.: 9.800-5091.01-4

Issue: 3; 18.03.10

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